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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/597,136	07/12/2006	Kenji Kitamura	SHM-16693	6533
	7590 04/29/200 L & CLARK LLP	EXAMINER		
38210 Glenn A	venue	LI, MEIYA		
WILLOUGHD	Y, OH 44094-7808		ART UNIT	PAPER NUMBER
			2811	
		MAIL DATE	DELIVERY MODE	
			04/29/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Communication		Application	on No.	Applicant(s)				
		10/597,13	36	KITAMURA ET AL.				
	Office Action Summary	Examiner		Art Unit				
		MEIYA LI		2811				
Period fo	The MAILING DATE of this communication or Reply	appears on the	cover sheet with the c	orrespondence ad	ddress			
WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR RECHEVER IS LONGER, FROM THE MAILING asions of time may be available under the provisions of 37 CF SIX (6) MONTHS from the mailing date of this communication of period for reply is specified above, the maximum statutory per to reply within the set or extended period for reply will, by streply received by the Office later than three months after the need patent term adjustment. See 37 CFR 1.704(b).	G DATE OF THE R 1.136(a). In no even n. eriod will apply and w statute, cause the app	IIS COMMUNICATION ent, however, may a reply be tin II expire SIX (6) MONTHS from lication to become ABANDONE	N. nely filed the mailing date of this of D (35 U.S.C. § 133).	•			
Status								
1) 又	Responsive to communication(s) filed on 1	12 February 20	าย					
-		This action is n						
3)	, <del></del>							
٠,١	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposit	on of Claims							
4)⊠	Claim(s) 1-3 is/are pending in the application	on.						
	4a) Of the above claim(s) is/are withdrawn from consideration.							
	5) Claim(s) is/are allowed.							
	6)⊠ Claim(s) <u>1-3</u> is/are rejected.							
-	Claim(s) is/are objected to.							
-	Claim(s) are subject to restriction ar	nd/or election r	equirement.					
	on Papers							
	· The specification is objected to by the Exan	miner						
•			Objected to by the I	- - - - - - - - - - - - - - - - - - -				
.0/	10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).								
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.								
	ınder 35 U.S.C. § 119							
	<u>-</u>	eian priority up	der 35 II S.C. & 110/a	\-(d) or (f)				
	12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a)	a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.							
	<ul> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage</li> </ul>							
	<u> </u>							
application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.								
Oce the attached detailed Office action for a list of the certified copies flot received.								
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Attachmen			Δ	(DTO 440)				
1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  Paper No(s)/Mail Date								
3) Information Disclosure Statement(s) (PTO/SB/08)  5) Notice of Informal Patent Application								
Paper No(s)/Mail Date 6) Other:								

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#### **DETAILED ACTION**

### Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
   The specification shall conclude with one or more claims particularly pointing out and distinctly
  - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claims 1-3 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 3. The claimed limitation of "the guard ring", as recited in claim 1, is unclear as to which element is the guard ring. Also unclear as to the structural relationship between the guard ring and the semiconductor device module.

## Claim Rejections - 35 USC § 103

- 4. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 5. Claims 1-2, as best understood, are rejected under 35 U.S.C. 103(a) as being unpatentable over Okura et al. (2003/0052400) in view of applicant's admitted prior art (""AAPA").

As for claim 1, Okura et al. show in Fig. 8 and related texts (see, i.e. [0068]- [0072]) a semiconductor device module structure comprising:

- a high-resistance layer 103 of a first conductive type N;
- a base layer 104 of a second conductive type P formed in an upper part of the high-resistance layer 103 of the first conductive type N;

an emitter region 105 of a first conductive type N formed in an upper part of the base layer 104 of the second conductive type P;

an emitter electrode 14 connected to the emitter region 105;

an insulated gate electrode 107 adjacent to the base layer 104 of the second conductive type P;

a guard ring part;

a passivation layer 3 formed on the upper part of the guard ring part and not extending onto an upper part of the cell region;

a collector layer 102 of the second conductive type P formed on the underside of the layer of the first conductive type N;

a collector electrode 113 connected to the collector layer 102; and
a metal flat plate upper heat-sinking part 4 connected to the emitter electrode 14
at a high such that it is non-contacting with the passivation film 3.

Okura et al. do not explicitly state that the part is guard ring part around the cell region; a buffer layer of a first conductive type formed on an underside of the high-resistance layer of the first conductive type.

In the same field of endeavor, AAPA teaches guard ring part around the cell region; a buffer layer of a first conductive type N formed on an underside of the high-resistance layer of the first conductive type N (Figs. 5-6).

It would have been obvious to one of ordinary skill in the art, at the time the invention was made, to include guard ring part around the cell region and the buffer

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layer, as taught by AAPA, in Okura et al.'s device, in order to provide a better protection of the device; and in order to improve the performance reliability of the device.

As for claim 2, the prior art combined device shows the semiconductor device module structure comprises a diode part, and wherein a cathode electrode located in an upper part of the diode part between the high-resistance layer and the upper heat sinking part is connected to the upper heat-sinking part.

6. Claim 3, as best understood, is rejected under 35 U.S.C. 103(a) as being unpatentable over Okura et al. (2003/0052400) and applicant's admitted prior art (""AAPA"), as applied to claim 1 above, further in view of Hirano et al. (2003/0122232).

Okura et al. and AAPA disclosed substantially the entire claimed invention, as applied to claim 1 above including one end of the metal fat plate upper heat-sinking part 4 is connected to the emitter electrode 14.

Okura et al. and AAPA do not explicitly state that the opposite end of the metal flat plate heat-sinking part is connected to a substrate.

In the same field of endeavor, Hirano et al. teach the opposite end 50a of the metal flat plate heat-sinking part 50 is connected to a substrate 46 (Fig. 14).

It would have been obvious to one of ordinary skill in the art, at the time the invention was made, to include the structure of heat-sinking part, as taught by Hirano et al., in Okura et al. and AAPA's device, in order to provide a better heat dissipation of the device.

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# Response to Arguments

7. Applicant's arguments with respect to claims 1-3 have been considered but are moot in view of the new ground(s) of rejection.

#### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to MEIYA LI whose telephone number is (571)270-1572. The examiner can normally be reached on Monday-Friday 7:30AM-5:00PM Eastern Standard Time.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynne Gurley can be reached on (571) 272-1670. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/M. L./ Examiner, Art Unit 2811 4/21/2008

/Ori Nadav/

Primary Examiner, Art Unit 2811